SGM8957-1/SGM8957-2
1.8V, Micro-Power CMOS
Zero-Drift Operational Amplifiers

PRODUCT DESCRIPTION

The single SGM8957-1 and dual SGM8957-2 CMOS operational amplifiers provide very low offset voltage and zero-drift over time and temperature.

The miniature, high-precision, low quiescent current amplifiers offer high-impedance inputs that have a wide input common mode range 100mV beyond the rails and rail-to-rail output that swings within 14mV of the rails. Single or dual supplies as low as +1.8V (±0.9V) and up to +5.5V (±2.75V) may be used. They are optimized for low voltage, single supply operation.

The SGM8957-1/-2 offer excellent CMRR without the crossover associated with traditional complementary input stages. This design results in superior performance for driving analog-to-digital converters (ADCs) without degradation of differential linearity.

The single SGM8957-1 is available in Green SOT-23-5, SC70-5 and SOIC-8 packages. The dual SGM8957-2 is available in Green SOIC-8, MSOP-8 and TDFN-3×3-8L packages. They are specified over -40℃ to +125℃ temperature range.

FEATURES

- **Low Offset Voltage: 25µV (MAX)**
- **Low 0.1Hz to 10Hz Noise: 2µV$_{P-P}$**
- **Quiescent Current: 20µA/Amplifier (TYP)**
- **Single Supply Operation**
- **Integrated RFI Filter**
- **Supply Voltage Range: 1.8V to 5.5V**
- **Rail-to-Rail Input/Output**
- **-40℃ to +125℃ Operating Temperature Range**
- **Small Packaging:**
  SGM8957-1 Available in Green SOT-23-5, SC70-5 and SOIC-8 Packages
  SGM8957-2 Available in Green SOIC-8, MSOP-8 and TDFN-3×3-8L Packages

APPLICATIONS

Transducer Applications
Temperature Measurements
Electronic Scales
Medical Instrumentation
Battery-Powered Instrument
Handheld Test Equipment

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8957-1	SOT-23-5	-40℃ to +125℃	SGM8957-1XN5G/TR	SYBXX	Tape and Reel, 3000
	SC70-5	-40℃ to +125℃	SGM8957-1XC5G/TR	SYCXX	Tape and Reel, 3000
	SOIC-8	-40℃ to +125℃	SGM8957-1XS8G/TR	SGM 89571XS8 XXXXX	Tape and Reel, 2500
SGM8957-2	SOIC-8	-40℃ to +125℃	SGM8957-2XS8G/TR	SGM 89572XS8 XXXXX	Tape and Reel, 2500
	MSOP-8	-40℃ to +125℃	SGM8957-2XMS8G/TR	SGM89572 XMS8 XXXXX	Tape and Reel, 4000
	TDFN-3×3-8L	-40℃ to +125℃	SGM8957-2XTDB8G/TR	SGM 09DB XXXXX	Tape and Reel, 4000

NOTE: XX = Date Code. XXXXX = Date Code and Vendor Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage...6V

Input Common Mode Voltage Range

.... $(-V_S) - 0.3V$ to $(+V_S) + 0.3V$

Junction Temperature...+150℃

Storage Temperature Range ....-65℃ to +150℃

Lead Temperature (Soldering 10sec) ....+260℃

ESD Susceptibility

HBM..4000V

MM...400V

CDM 1000V

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range ....1.8V to 5.5V

Operating Temperature Range ....-40℃ to +125℃

MARKING INFORMATION

SYY X X

— Date code - Month ("A" = Jan. "B" = Feb. ⋯ "L" = Dec.)

— Date code - Year ("A" = 2010, "B" = 2011 ⋯)

— Chip I.D.
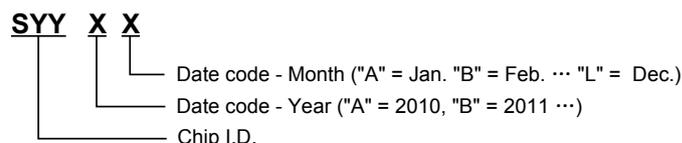
For example: SYBEA (2014, January)

OVERSTRESS CAUTION

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.

PIN CONFIGURATIONS
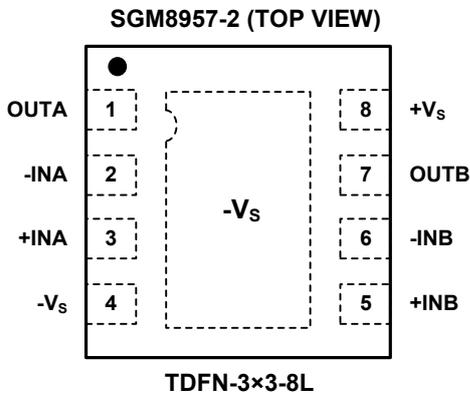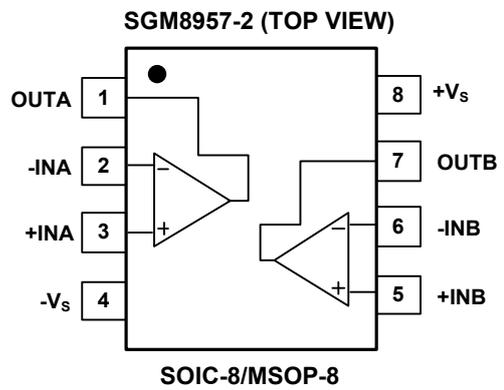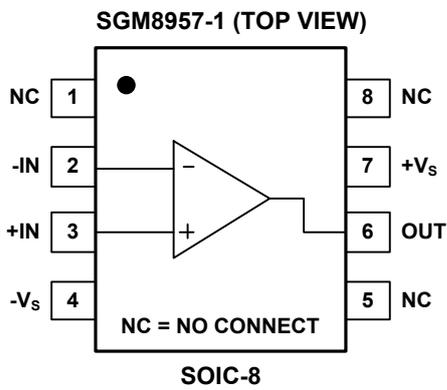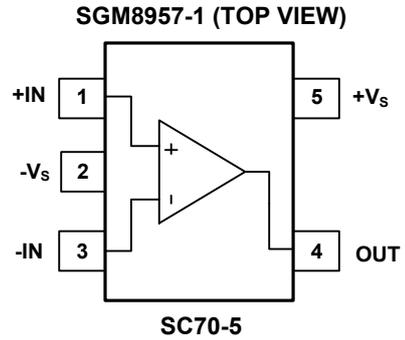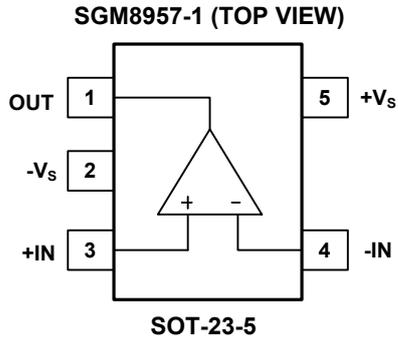
SGM8957-1 (TOP VIEW)

OUT	1		5	+V_S
-V_S	2			
+IN	3		4	-IN

SOT-23-5

SGM8957-1 (TOP VIEW)

+IN	1		5	+V_S
-V_S	2			
-IN	3		4	OUT

SC70-5

SGM8957-1 (TOP VIEW)

NC	1		8	NC
-IN	2		7	+V_S
+IN	3		6	OUT
-V_S	4		5	NC

NC = NO CONNECT

SOIC-8

SGM8957-2 (TOP VIEW)

OUTA	1		8	+V_S
-INA	2		7	OUTB
+INA	3		6	-INB
-V_S	4		5	+INB

SOIC-8/MSOP-8

SGM8957-2 (TOP VIEW)

OUTA	1		8	+V_S
-INA	2		7	OUTB
+INA	3	-V_S	6	-INB
-V_S	4		5	+INB

TDFN-3×3-8L

ELECTRICAL CHARACTERISTICS

(At T_A = +25℃, V_S = 1.8V to 5.5V, V_{CM} = +V_S/2, V_{OUT} = +V_S/2, and R_L = 10kΩ to +V_S/2, unless otherwise noted.)

| PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
INPUT CHARACTERISTICS					
Input Offset Voltage (V_{OS})	V_S = 5V		14	25	μV
	-40℃ ≤ T_A ≤ +125℃			55	
Input Offset Voltage Drift ($\Delta V_{OS}/\Delta T$)	-40℃ ≤ T_A ≤ +125℃		0.08		μV/℃
Input Bias Current (I_B)			130		pA
Input Common Mode Voltage Range (V_{CM})		(-V_S) - 0.1		(+V_S) + 0.1	V
Common Mode Rejection Ratio (CMRR)	(-V_S) - 0.1V < V_{CM} < (+V_S) + 0.1V	89	100		dB
	-40℃ ≤ T_A ≤ +125℃	85			
Open-Loop Voltage Gain (A_{OL})	(-V_S) + 0.1V < V_O < (+V_S) - 0.1V, R_L = 10kΩ	95	121		dB
	-40℃ ≤ T_A ≤ +125℃	94			
INPUT IMPEDANCE					
Differential			10^9		Ω
Common Mode			10^9		Ω
OUTPUT CHARACTERISTICS					
Output Voltage Swing from Rail	R_L = 10kΩ		14	25	mV
	-40℃ ≤ T_A ≤ +125℃			27	
Short-Circuit Current (I_{SC})	V_S = +1.8V		6		mA
	V_S = 5V		60		
Open-Loop Output Impedance	f = 350kHz, I_O = 0		1		kΩ
POWER SUPPLY					
Specified Voltage Range (V_S)		1.8		5.5	V
Power Supply Rejection Ratio (PSRR)	V_S = 1.8V to 5.5V		4	20	μV/V
	-40℃ ≤ T_A ≤ +125℃			25	
Quiescent Current/Amplifier (I_Q)	I_O = 0		20	37	μA
	-40℃ ≤ T_A ≤ +125℃			48	
Turn-On Time	V_S = 5V		220		μs
DYNAMIC PERFORMANCE					
Gain-Bandwidth Product (GBP)	C_L = 100pF		350		kHz
Slew Rate (SR)	G = +1		0.18		V/μs
NOISE					
Input Voltage Noise	f = 0.1Hz to 10Hz		2		μV$_{P-P}$

TYPICAL PERFORMANCE CHARACTERISTICS

At T_A = +25℃, V_S = 5V, and C_L = 0pF, unless otherwise noted.

Common Mode Rejection Ratio vs. Frequency

Power Supply Rejection Ratio vs. Frequency

Output Voltage Swing vs. Output Current

Output Voltage Swing vs. Output Current

Quiescent Current vs. Temperature

Settling Time vs. Closed-Loop Gain

TYPICAL PERFORMANCE CHARACTERISTICS

At T_A = +25°C, V_S = 5V, and C_L = 0pF, unless otherwise noted.

Large-Signal Step Response
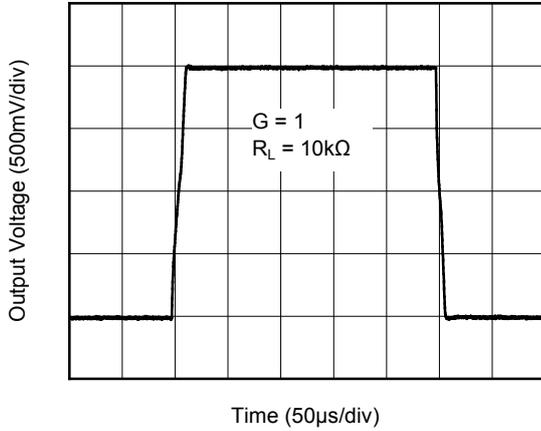
G = 1
R_L = 10kΩ

Output Voltage (500mV/div)

Time (50μs/div)

Small-Signal Step Response

G = 1
R_L = 10kΩ

Output Voltage (50mV/div)

Time (5μs/div)

Positive Over-Voltage Recovery

0V
V_{IN}

V_{OUT}

0V

G = -10
R_L = 10kΩ

2V/div

1V/div

Time (50μs/div)

Negative Over-Voltage Recovery

V_{IN}

0V

0V

V_{OUT}

G = -10
R_L = 10kΩ

2V/div

1V/div

Time (50μs/div)
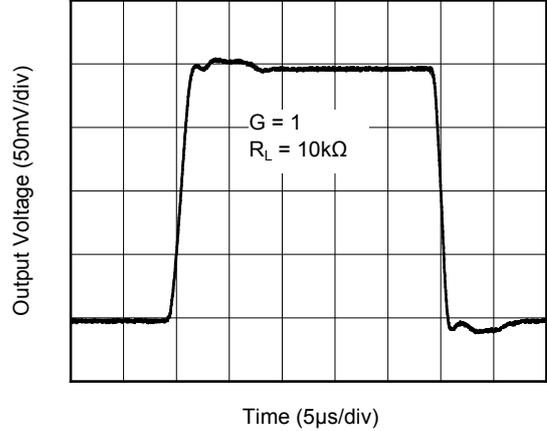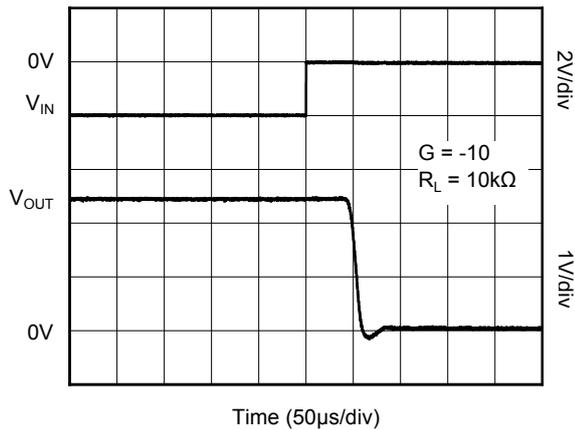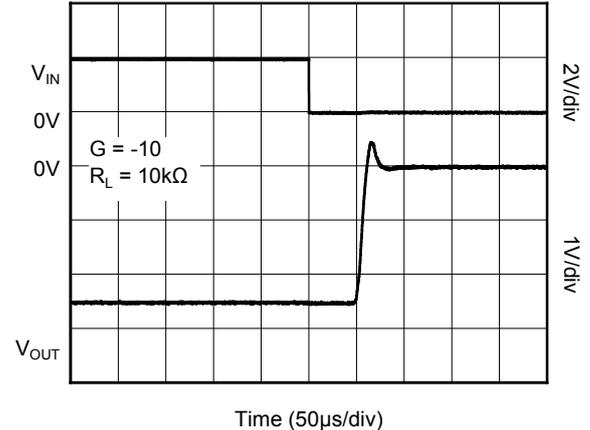
Small-Signal Overshoot vs. Load Capacitance

Small-Signal Overshoot (%)

Load Capacitance (pF)

0.1Hz to 10Hz Noise

Noise (500nV/div)

Time (1s/div)

TYPICAL PERFORMANCE CHARACTERISTICS

At T_A = +25℃, V_S = 5V, and C_L = 0pF, unless otherwise noted.

Voltage Noise Spectral Density vs. Frequency

Continues with no 1/f (flicker) noise.

Offset Voltage Production Distribution

15000 Samples
1 Production Lot

V_S = 5V

APPLICATION INFORMATION

The SGM8957-1 and SGM8957-2 are unity-gain stable and free from unexpected output phase reversal. They provide low offset voltage and very low drift over time and temperature. For lowest offset voltage and precision performance, circuit layout and mechanical conditions should be optimized. Avoid temperature gradients that create thermoelectric (Seebeck) effects in the thermocouple junctions formed from connecting dissimilar conductors. These thermally-generated potentials can be made to cancel by assuring they are equal on both input terminals. Other layout and design considerations include:
• Use low thermoelectric-coefficient conditions (avoid dissimilar metals).
• Thermally isolate components from power supplies or other heat sources.
• Shield operational amplifier and input circuitry from air currents, such as cooling fans.
Following these guidelines will reduce the likelihood of junctions being at different temperatures, which can cause thermoelectric voltages of 0.08μV/℃ or higher, depending on materials used.

Operating Voltage
The SGM8957-1 and SGM8957-2 operational amplifiers operate over a power supply range of +1.8V to +5.5V (±0.9V to ±2.75V). Supply voltages higher than +6V (absolute maximum) can permanently damage the device.

Input Voltage
The SGM8957-1 and SGM8957-2 input common mode voltage range extends 0.1V beyond the supply rails. The SGM8957-1 is designed to cover the full range without the troublesome transition region found in some other rail-to-rail amplifiers.

Normally, input bias current is about 130pA; however, input voltages exceeding the power supplies can cause excessive current to flow into or out of the input pins. Momentary voltages greater than the power supply can be tolerated if the input current is limited to 10mA. This limitation is easily accomplished with an input resistor, as shown in Figure 1.

Internal Offset Correction
The SGM8957-1 and SGM8957-2 operational amplifiers use an auto-calibration technique with a time-continuous 350kHz operational amplifier in the signal path. Upon power-up, the amplifier requires approximately 220μs to achieve specified VOS accuracy.

Achieving Output Swing to The Operational Amplifier Negative Rail
Some applications require output voltage swings from 0V to a positive full-scale voltage (such as +2.5V) with excellent accuracy. With most single-supply operational amplifiers, problems arise when the output signal approaches 0V, near the lower output swing limit of a single-supply operational amplifier. A good single-supply operational amplifier may swing close to single-supply ground, but will not reach ground. The output of the SGM8957-1 and SGM8957-2 can be made to swing to ground, or slightly below, on a single-supply power source. To do so requires the use of another resistor and an additional, more negative, power supply than the operational amplifier negative supply. A pull-down resistor may be connected between the output and the additional negative supply to pull the output down below the value that the output would otherwise achieve, as shown in Figure 2.
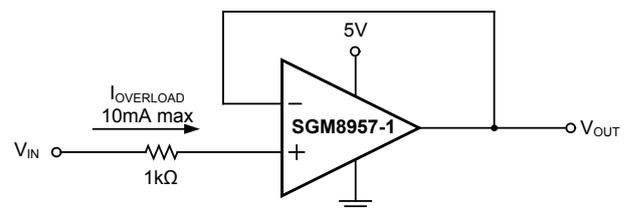
NOTE: Current-limiting resistor required if input voltage exceeds supply rails by ≥ 0.5V.

Figure 1. Input Current Protection
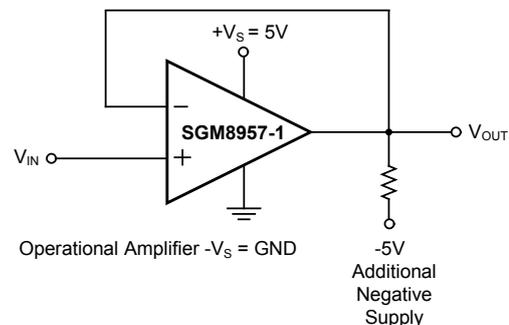
Figure 2. For V$_{OUT}$ Range to Ground

APPLICATION INFORMATION
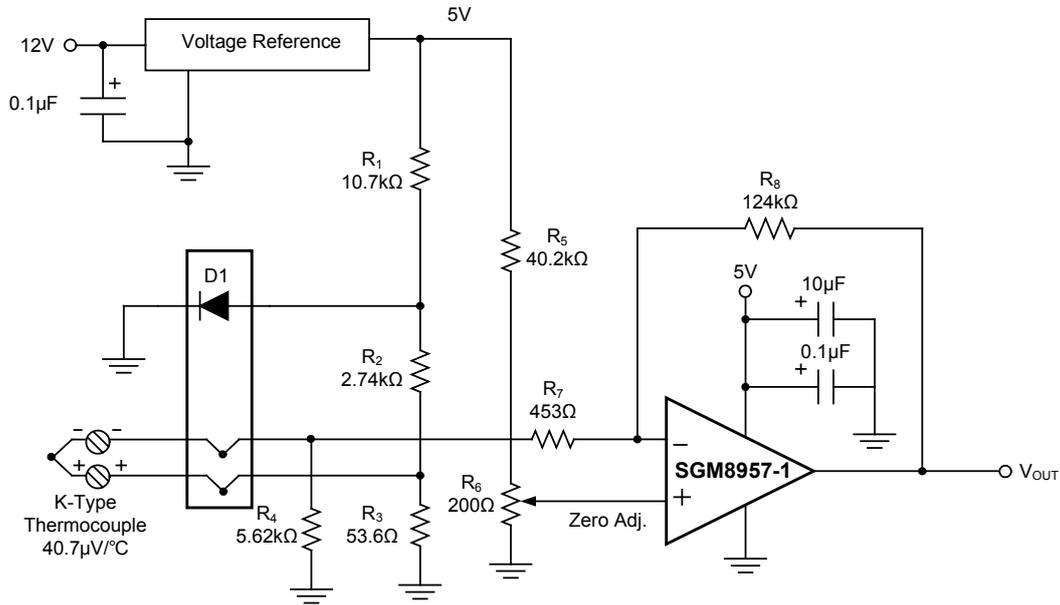
Figure 3. Temperature Measurement

General Layout Guidelines

Attention to good layout practices is always recommended. Keep traces short and, when possible, use a printed circuit board (PCB) ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1µF capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the EMI (electromagnetic-interference) susceptibility. Operational amplifiers vary in their susceptibility to radio frequency interference (RFI). RFI can generally be identified as a variation in offset voltage or DC signal levels with changes in the interfering RF signal. The SGM8957-1 has been specifically designed to minimize susceptibility to RFI and demonstrates remarkably low sensitivity compared to previous generation devices. Strong RF fields may still cause varying offset levels.

Figure 4 shows the basic configuration for a bridge amplifier.

A low-side current shunt monitor is shown in Figure 5. R_N are operational resistors used to isolate the ADC from the noise of the digital I^2C bus. Since the ADC is a 16-bit converter, a precise reference is essential for maximum accuracy. Related application circuits are shown in Figure 6 ~ 8.
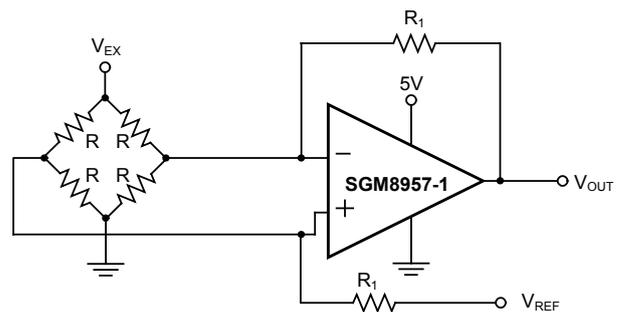

Figure 4. Single Operational Amplifier Bridge Amplifier

APPLICATION INFORMATION
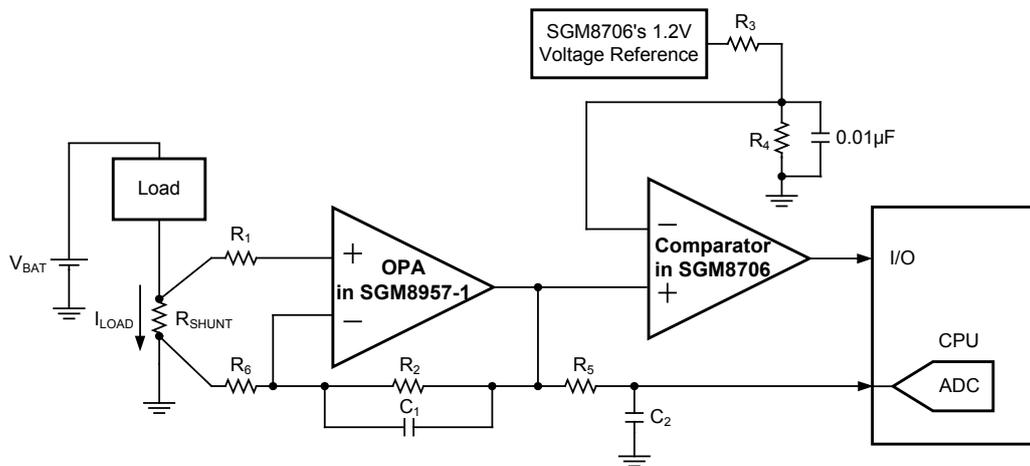
Figure 5. Low-side Current Monitor
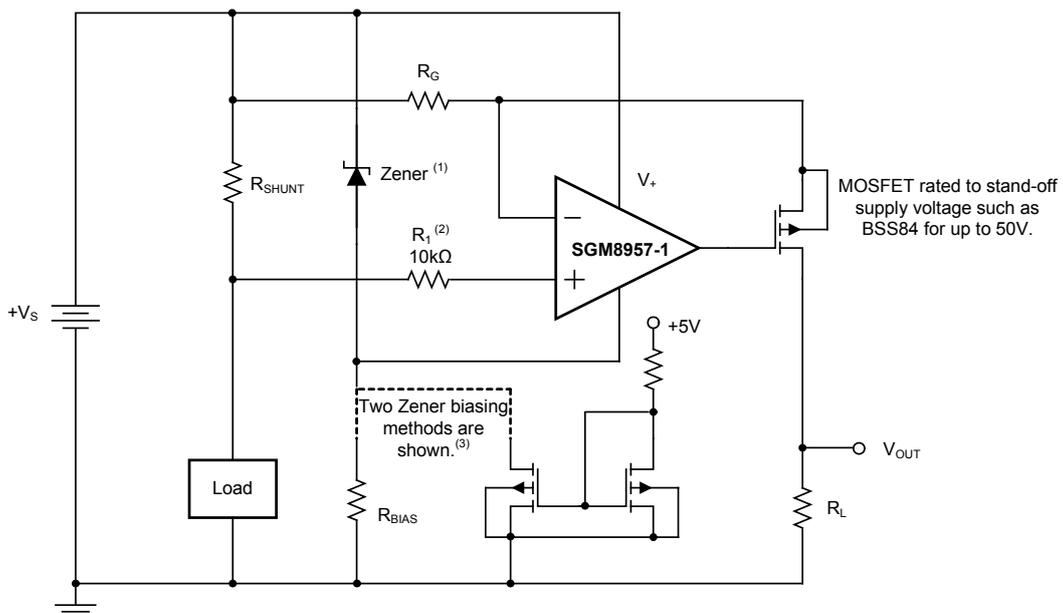
NOTES: (1) Zener rated for op amp supply capability (that is, 5.1V for SGM8957-1).
(2) Current-limiting resistor.
(3) Choose Zener biasing resistor or dual NMOSFETs (FDG6301N, NTJD4001N, or Si1034).

Figure 6. High-side Current Monitor

APPLICATION INFORMATION
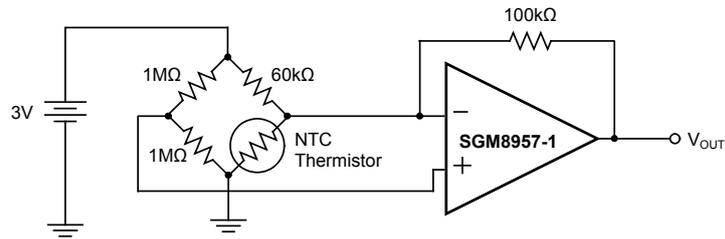

Figure 7. Thermistor Measurement

$$V_O = (1 + 2R_2/R_1)(V_2 - V_1)$$
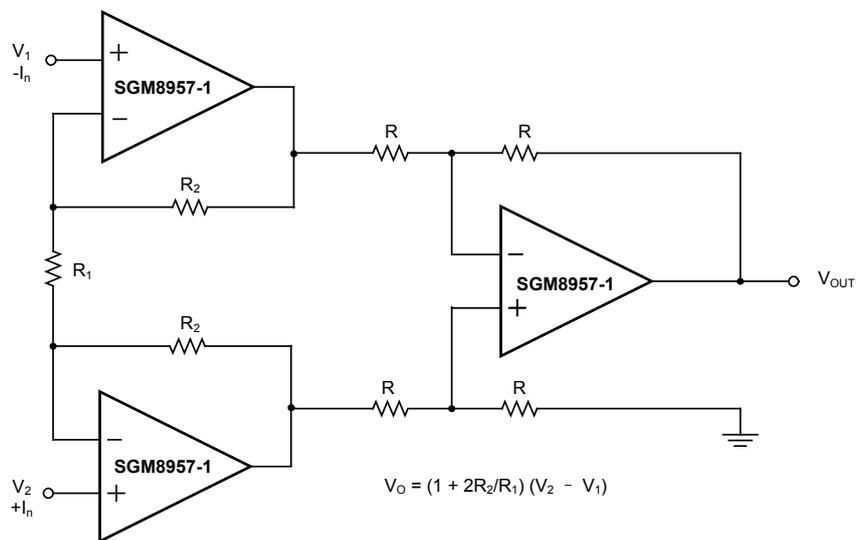
Figure 8. Precision Instrumentation Amplifier

PACKAGE OUTLINE DIMENSIONS

SOT-23-5
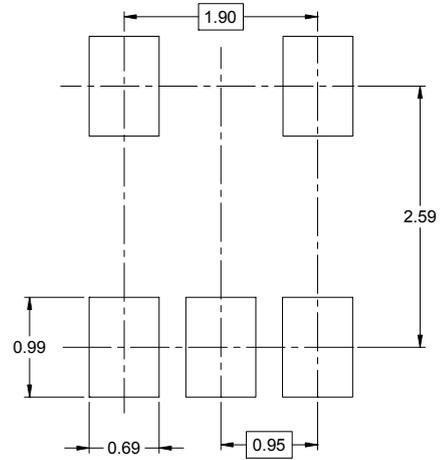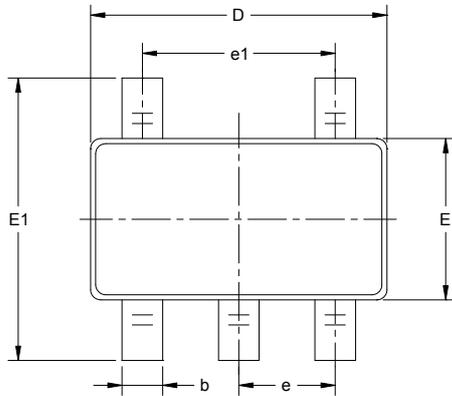
RECOMMENDED LAND PATTERN (Unit: mm)
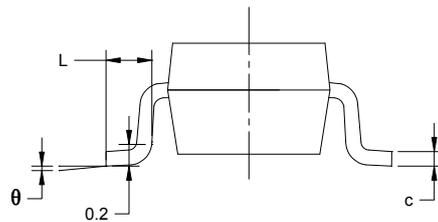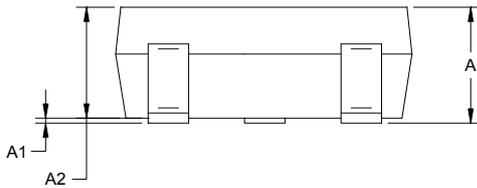
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

TX00033.000

PACKAGE OUTLINE DIMENSIONS

SC70-5
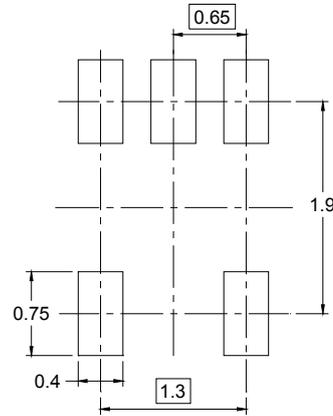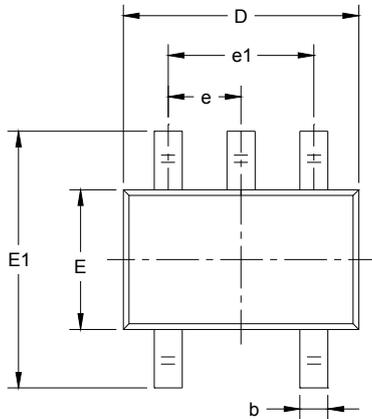
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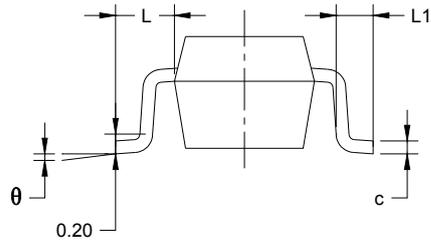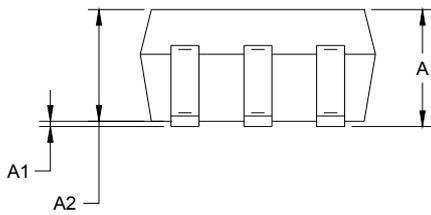
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.65 TYP		0.026 TYP	
e1	1.300 BSC		0.051 BSC	
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

TX00043.000

PACKAGE OUTLINE DIMENSIONS

SOIC-8

RECOMMENDED LAND PATTERN (Unit: mm)
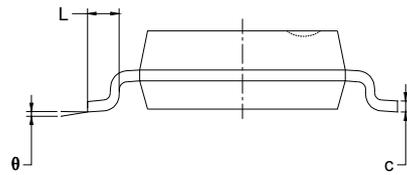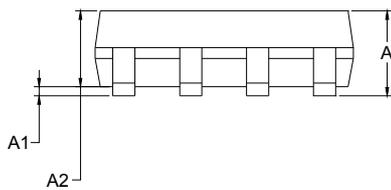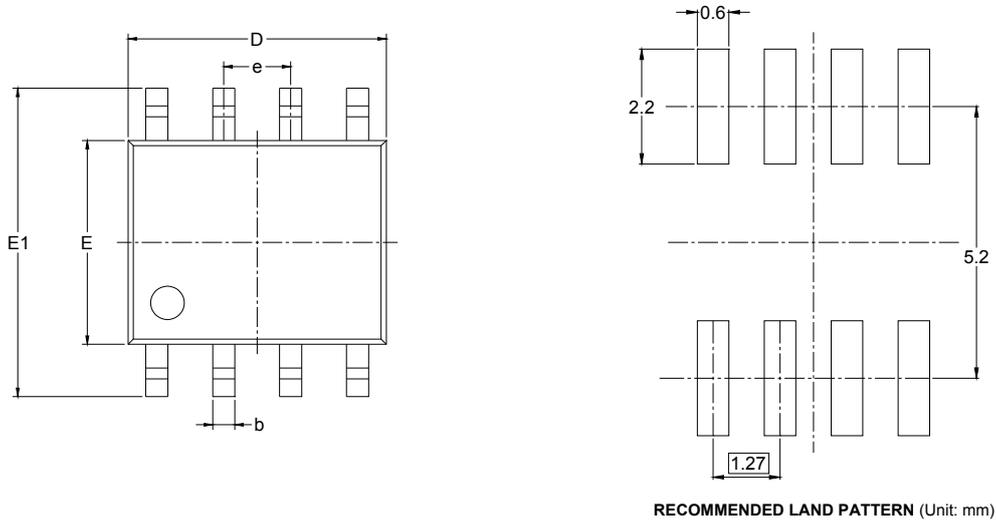
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

TX00010.000

PACKAGE OUTLINE DIMENSIONS

MSOP-8
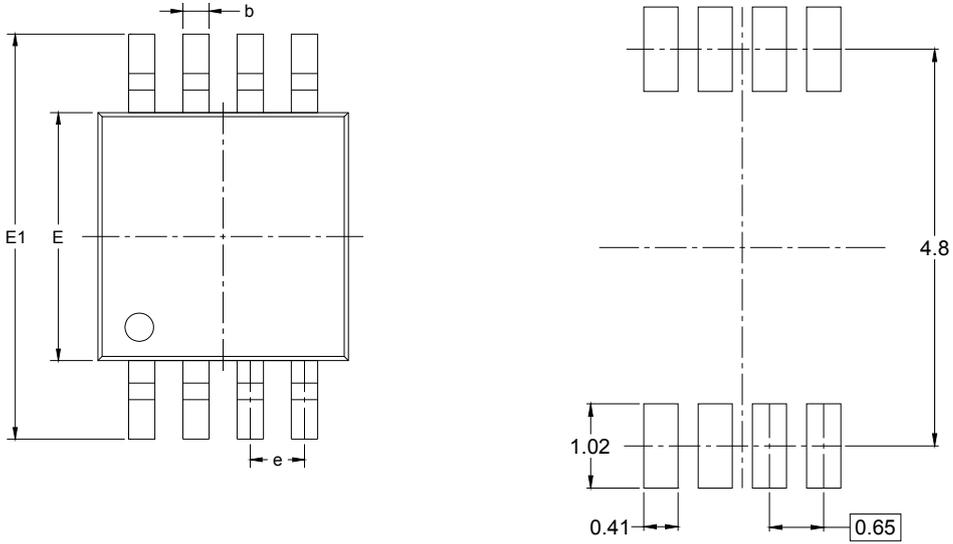
RECOMMENDED LAND PATTERN (Unit: mm)
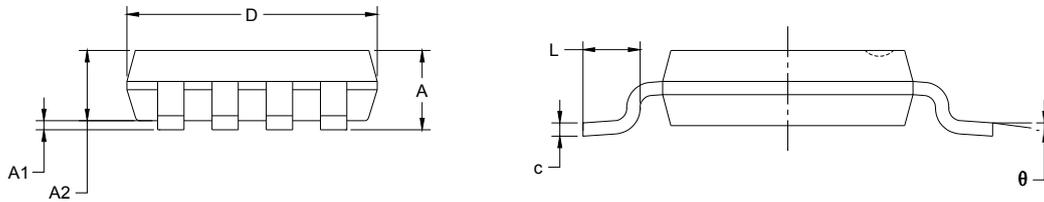
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	**MAX**	**MIN**	**MAX**
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.650 BSC		0.026 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TX00014.000

PACKAGE OUTLINE DIMENSIONS

TDFN-3×3-8L
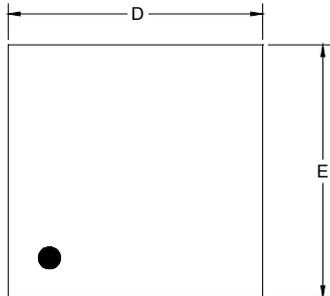
TOP VIEW
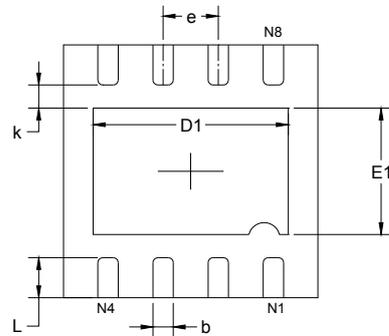
BOTTOM VIEW
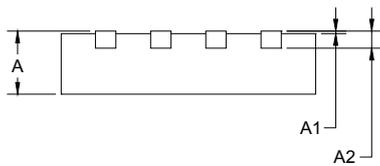
SIDE VIEW
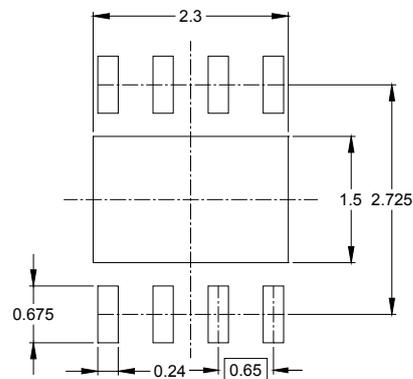
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 REF		0.008 REF	
D	2.900	3.100	0.114	0.122
D1	2.200	2.400	0.087	0.094
E	2.900	3.100	0.114	0.122
E1	1.400	1.600	0.055	0.063
k	0.200 MIN		0.008 MIN	
b	0.180	0.300	0.007	0.012
e	0.650 TYP		0.026 TYP	
L	0.375	0.575	0.015	0.023

TAPE AND REEL INFORMATION

REEL DIMENSIONS
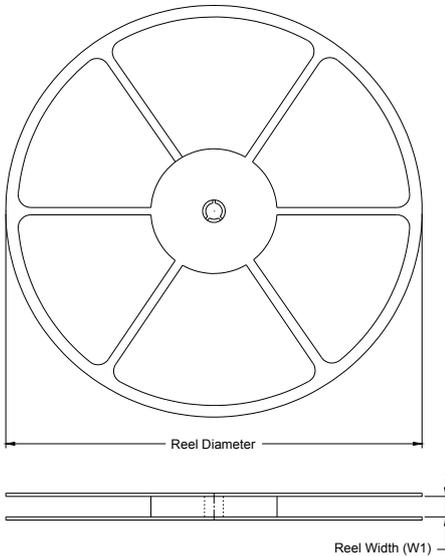
TAPE DIMENSIONS
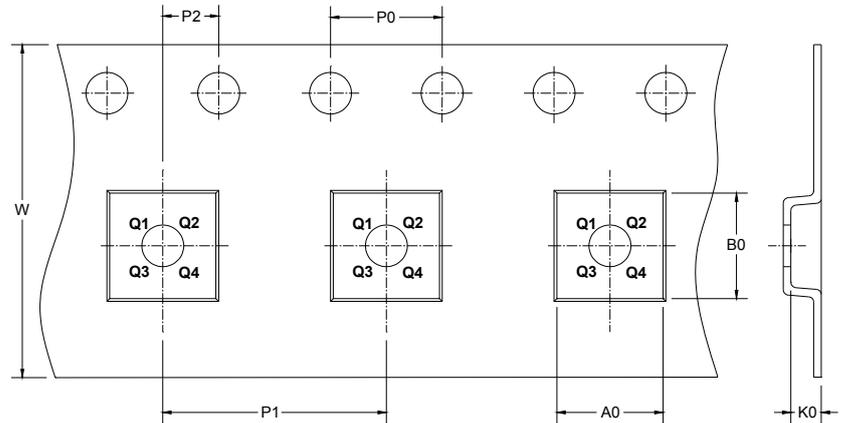
DIRECTION OF FEED

NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7″	9.5	3.2	3.2	1.4	4.0	4.0	2.0	8.0	Q3
SC70-5	7″	9.5	2.25	2.55	1.20	4.0	4.0	2.0	8.0	Q3
SOIC-8	13″	12.4	6.4	5.4	2.1	4.0	8.0	2.0	12.0	Q1
MSOP-8	13″	12.4	5.2	3.3	1.5	4.0	8.0	2.0	12.0	Q1
TDFN-3×3-8L	13″	12.4	3.35	3.35	1.13	4.00	8.00	2.00	12.00	Q1

DD0001

CARTON BOX DIMENSIONS
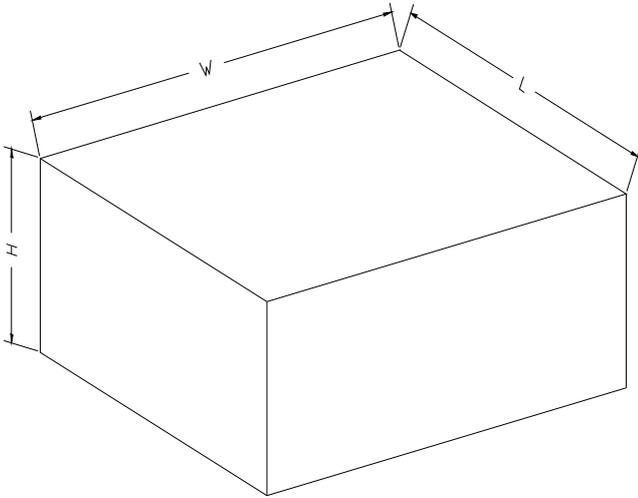
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7″ (Option)	368	227	224	8
7″	442	410	224	18
13″	386	280	370	5

DD0002